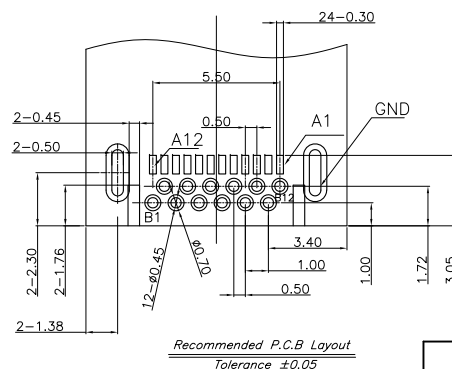
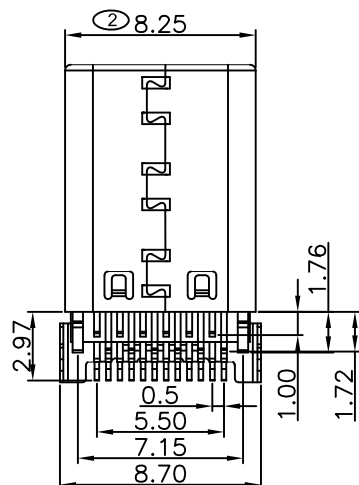
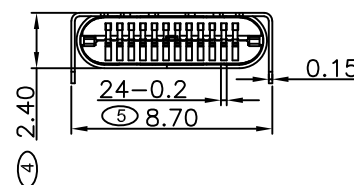
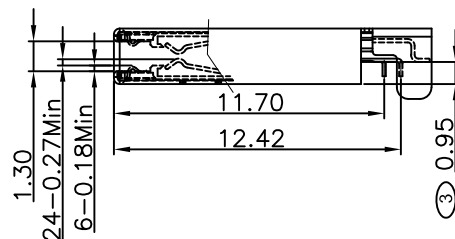
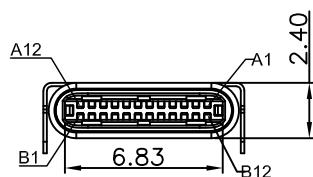
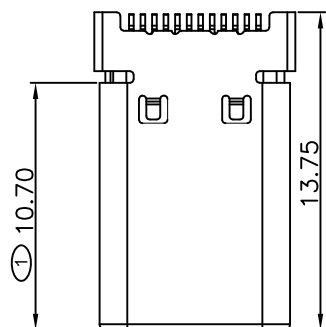




1.Material:

Contacts: Copper alloy T=0.15
Insulator: LCP UL 94V-0,
Shell: STEEL T=0.15

2.Electrical:

Current-max[amps]: 5A Max For Vbus/GND PIN;
0.9A Max For Other PIN.

Withstanding Voltage: 100V AC R.M.S

Contact Resistance [ohms]: 40mΩ Max.For
Initial 10mΩ.Change Afier
Test.Measure AT 20mV,100mA

Insulation Resistance [ohms]: 100 mΩ min.

3.MECHANICAL CHARACTERISTICS:

Mating force: 5~20N

Unmated Force: 6~20N After test.

Durability: 10000 cycles min.

4.Plating:

Contacts: Au plated on contact area,
Bright Tin plating 80~100U"Min on solder area
Nickel Under plating 20u"Min over all

Shell : plating 20~50U"Nickel over CU

5.Environmental

Temperature Range: -40°C~+85°C

※ SIGN "⊗" IS IMPORTANCE DIMENSION

A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1
GND	RX2+	RX2-	V _{BUS}	SBU1	D-	D+	CC	V _{BUS}	TX1-	TX1+	GND
GND	TX2+	TX2-	V _{BUS}	Vconn			SBU2	V _{BUS}	RX1-	RX1+	GND
B1	B2	B3	B4	B5	B6	B7	B8	B9	B10	B11	B12

KEM 奇速科技有限公司
Qi-Speed Technology CO., LTD.

產品名稱:
PRODUCT NAME

USB CM 90度DIP+SMT FOR PCB DIP

單位: mm	繪圖	設計	審核	核准	料號: KUSBC010-M001
比例:	DRAWING	DESIGNED	CHECKED BY	APPROVAL BY	PART NUMBER
公差: .X ±0.38 .XX ±0.25 .XXX ±0.13	JOHNY	JOHNY	LUKE	JAMES	圖號: KUSBC010-M001-1 DRAWING NO
日期: 2021/4/20					版本: REV. 0

版本	修改事項	修改日期